

# S-57K1 A Series

## FOR AUTOMOTIVE 125°C OPERATION HIGH-WITHSTAND VOLTAGE HIGH-SPEED BIPOLAR HALL EFFECT LATCH IC

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Rev.1.6 02

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This IC, developed by CMOS technology, is a high-accuracy Hall effect latch IC that operates with high temperature and high-withstand voltage.

The output voltage changes when this IC detects the intensity level of magnetic flux density and a polarity change. Using this IC with a magnet makes it possible to detect the rotation status in various devices.

This IC includes a reverse voltage protection circuit and an output current limit circuit.

High-density mounting is possible by using the small SOT-23-3 package.

Due to its high-accuracy magnetic characteristics, this IC can make operation's dispersion in the system combined with magnet smaller.

ABLIC Inc. offers a "magnetic simulation service" that provides the ideal combination of magnets and our Hall effect ICs for customer systems. Our magnetic simulation service will reduce prototype production, development period and development costs. In addition, it will contribute to optimization of parts to realize high cost performance. For more information regarding our magnetic simulation service, contact our sales office.

# Caution This product can be used in vehicle equipment and in-vehicle equipment. Before using the product in the purpose, contact to ABLIC Inc. is indispensable.

## Features

Pole detection:	Bipolar latch
<ul> <li>Output logic<sup>*1</sup>:</li> </ul>	V <sub>OUT</sub> = "L" at S pole detection
• Output form <sup>*1</sup> :	V <sub>OUT</sub> = "H" at S pole detection Nch open-drain output, Nch driver + built-in pull-up resistor
<ul> <li>Magnetic sensitivity<sup>*1</sup>:</li> </ul>	$B_{OP} = 3.0 \text{ mT typ.}$ $B_{OP} = 6.0 \text{ mT typ.}$
<ul> <li>Chopping frequency:</li> </ul>	$f_{\rm C}$ = 500 kHz typ.
<ul> <li>Output delay time:</li> </ul>	t <sub>D</sub> = 8.0 μs typ.
<ul> <li>Power supply voltage range:</li> </ul>	V <sub>DD</sub> = 3.5 V to 26.0 V
<ul> <li>Built-in regulator</li> <li>Built-in reverse voltage protection circuit</li> <li>Built-in output current limit circuit</li> <li>Operation temperature range:</li> <li>Lead-free (Sn 100%), halogen-free</li> <li>AEC-Q100 qualified<sup>*2</sup></li> </ul>	Ta = -40°C to +125°C

**\*1.** The option can be selected.

**\*2.** Contact our sales office for details.

## Applications

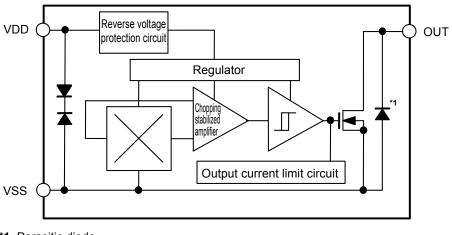
- Automobile equipment
- Home appliance
- DC brushless motor
- Housing equipment
- Industrial equipment

## Package

• SOT-23-3

## Block Diagrams

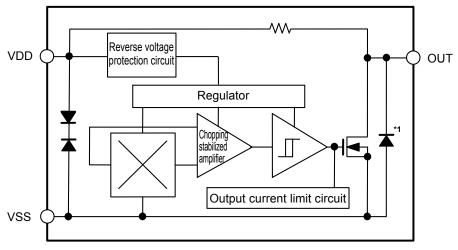
## 1. Nch open-drain output product



\*1. Parasitic diode



## 2. Nch driver + built-in pull-up resistor product



\*1. Parasitic diode

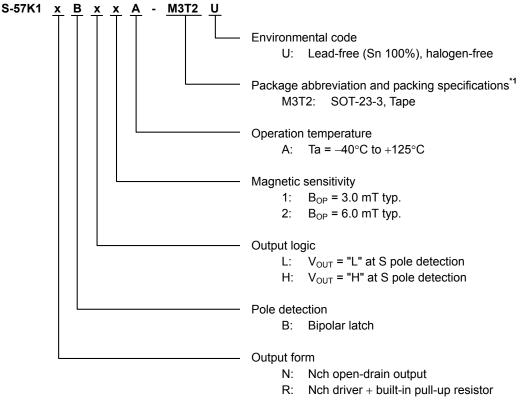
Figure 2

## ■ AEC-Q100 Qualified

This IC supports AEC-Q100 for operation temperature grade 1. Contact our sales office for details of AEC-Q100 reliability specification.

# Product Name Structure

1. Product name



\*1. Refer to the tape drawing.

#### 2. Package

Table 1 Package Drawing Codes

Package Name	Dimension	Таре	Reel
SOT-23-3	MP003-C-P-SD	MP003-C-C-SD	MP003-Z-R-SD

#### 3. Product name list

Table 2

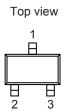
Product Name	Output Form	Pole Detection	Output Logic	Magnetic Sensitivity (B <sub>OP</sub> )
S-57K1NBL1A-M3T2U	Nch open-drain output	Bipolar latch	V <sub>OUT</sub> = "L" at S pole detection	3.0 mT typ.
S-57K1NBL2A-M3T2U	Nch open-drain output	Bipolar latch	V <sub>OUT</sub> = "L" at S pole detection	6.0 mT typ.
S-57K1NBH1A-M3T2U	Nch open-drain output	Bipolar latch	V <sub>OUT</sub> = "H" at S pole detection	3.0 mT typ.
S-57K1RBL1A-M3T2U	Nch driver + built-in pull-up resistor	Bipolar latch	V <sub>OUT</sub> = "L" at S pole detection	3.0 mT typ.

**Remark** Please contact our sales office for products other than the above.

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## Pin Configuration

## 1. SOT-23-3



Pin No.	Symbol	Description
1	VSS	GND pin
2	VDD	Power supply pin
3	OUT	Output pin

Table 3

Figure 3

# ■ Absolute Maximum Ratings

#### Table 4

			(Ta = +25°C unless otherwise s	specified)
	Item	Symbol	Absolute Maximum Rating	Unit
Power sup	oply voltage	V <sub>DD</sub>	$V_{\rm SS}-28.0$ to $V_{\rm SS}+28.0$	V
Output cu	rrent	I <sub>OUT</sub>	20	mA
Output	tput Nch open-drain output product		$V_{SS}{-}0.3$ to $V_{SS}{+}28.0$	V
voltage Nch driver + built-in pull-up resistor produc		V <sub>OUT</sub>	$V_{\text{SS}} - 0.3$ to $V_{\text{DD}} + 0.3$	V
Junction temperature		Tj	-40 to +150	°C
Operation ambient temperature		T <sub>opr</sub>	-40 to +125	°C
Storage temperature		T <sub>stg</sub>	-40 to +150	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

# Thermal Resistance Value

Table 5								
Item	Symbol	Conditi	on	Min.	Тур.	Max.	Unit	
	$\theta_{JA}$	SOT-23-3	Board A	-	200	Ι	°C/W	
			Board B	_	165	١	°C/W	
Junction-to-ambient thermal resistance*1			Board C	_	_	١	°C/W	
			Board D	-	_	_	°C/W	
			Board E	-	_	_	°C/W	

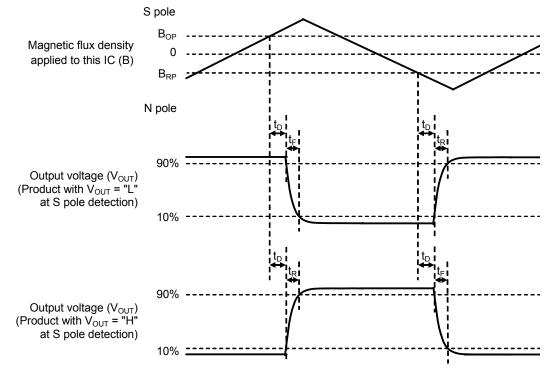
\*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

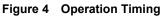
**Remark** Refer to "■ **Power Dissipation**" and "**Test Board**" for details.

# Electrical Characteristics

		(Ta = +25°C, V <sub>DD</sub> = 12.0 V, V	V <sub>SS</sub> = 0	V unles	s other	<i>w</i> ise sp	ecified)
Item	Symbol	Condition		Тур.	Max.	Unit	Test Circuit
Power supply voltage	V <sub>DD</sub>	-	3.5	12.0	26.0	V	-
Current consumption		Nch open-drain output product Average value	-	3.0	4.0	mA	1
Current consumption	I <sub>DD</sub>	Nch driver + built-in pull-up resistor product Average value, V <sub>OUT</sub> = "H"	-	3.0	4.0	mA	1
Current consumption		Nch open-drain output product $V_{DD} = -26.0 V$	-1	-	_	mA	1
during reverse connection	IDDREV	Nch driver + built-in pull-up resistor product $V_{DD} = -26.0 V$	-5	_	_	mA	1
Output voltage	V	Nch open-drain output product Output transistor Nch, $V_{OUT}$ = "L", $I_{OUT}$ = 10 mA	-	-	0.4	V	2
Output voltage	V <sub>OUT</sub>	Nch driver + built-in pull-up resistor product Output transistor Nch, $V_{OUT}$ = "L", $I_{OUT}$ = 10 mA	-	-	0.5	V	2
Output drop voltage	VD	Nch driver + built-in pull-up resistor product $V_{OUT} = "H", V_D = V_{DD} - V_{OUT}$		-	20	mV	2
Leakage current	I <sub>LEAK</sub>	Nch open-drain output product Output transistor Nch, $V_{OUT}$ = "H" = 26.0 V		-	10	μA	3
Output limit current	I <sub>OM</sub>	V <sub>OUT</sub> = 12.0 V	22	-	70	mA	3
Output delay time	t <sub>D</sub>	_	-	8.0	-	μS	-
Chopping frequency	f <sub>C</sub>	_	-	500	-	kHz	-
Start up time	t <sub>PON</sub>	_	-	20	_	μS	4
Output rise time	<b>.</b>	Nch open-drain output product C = 20 pF, R = 820 $\Omega$	-	-	2.0	μs	5
Output rise time	t <sub>R</sub>	Nch driver + built-in pull-up resistor product C = 20 pF	-	_	6.0	μS	5
Output fall time	t <sub>F</sub>	C = 20 pF, R = 820 Ω	-	_	2.0	μS	5
Pull-up resistor	RL	Nch driver + built-in pull-up resistor product	7	10	13	kΩ	-

Table 6





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## Magnetic Characteristics

### 1. Product with $B_{OP} = 3.0 \text{ mT typ.}$

			(Ta = +25	°C, V <sub>DD</sub> = 1	2.0 V, V <sub>SS</sub>	= 0 V unle	ss other	wise specified)
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Operation point <sup>*1</sup>	S pole	B <sub>OP</sub>	_	1.5	3.0	4.5	mT	4
Release point <sup>*2</sup>	N pole	B <sub>RP</sub>	_	-4.5	-3.0	-1.5	mT	4
Hysteresis width*3		B <sub>HYS</sub>	$B_{HYS} = B_{OP} - B_{RP}$	-	6.0	-	mT	4

Table 7

### 2. Product with $B_{OP} = 6.0 \text{ mT typ.}$

#### Table 8

			(Ta = +2	5°C, V <sub>DD</sub> = <sup>2</sup>	12.0 V, V <sub>SS</sub>	= 0 V unle	ess other	wise specified)
Iten	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Operation point <sup>*1</sup>	S pole	B <sub>OP</sub>	-	3.0	6.0	9.0	mT	4
Release point <sup>*2</sup>	N pole	B <sub>RP</sub>	-	-9.0	-6.0	-3.0	mT	4
Hysteresis width*3		B <sub>HYS</sub>	$B_{HYS} = B_{OP} - B_{RP}$	_	12.0	_	mT	4

\*1. B<sub>OP</sub>: Operation point

 $B_{OP}$  is the value of magnetic flux density when the output voltage (V<sub>OUT</sub>) changes after the magnetic flux density applied to this IC by the magnet (S pole) is increased (by moving the magnet closer).

 $V_{OUT}$  retains the status until a magnetic flux density of the N pole higher than  $B_{RP}$  is applied.

\*2.  $B_{RP}$ : Release point

 $B_{RP}$  is the value of magnetic flux density when the output voltage (V<sub>OUT</sub>) changes after the magnetic flux density applied to this IC by the magnet (N pole) is increased (by moving the magnet closer).

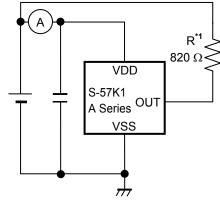
 $V_{\text{OUT}}$  retains the status until a magnetic flux density of the S pole higher than  $B_{\text{OP}}$  is applied.

#### \*3. B<sub>HYS</sub>: Hysteresis width

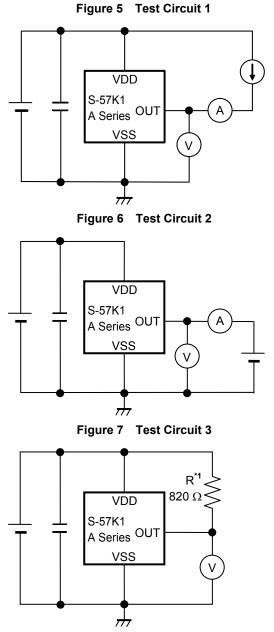
 $B_{HYS}$  is the difference of magnetic flux density between  $B_{OP}$  and  $B_{RP}$ .

**Remark** The unit of magnetic density mT can be converted by using the formula 1 mT = 10 Gauss.

## Test Circuits

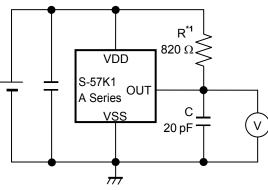


\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.



\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.
 Figure 8 Test Circuit 4

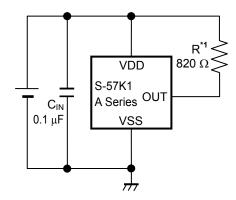
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\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 9 Test Circuit 5

# Standard Circuit



\*1. Resistor (R) is unnecessary for the pull-up resistor built-in product.

Figure 10

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

## Operation

#### 1. Direction of applied magnetic flux

This IC detects the magnetic flux density which is vertical to the marking surface. **Figure 11** shows the direction in which magnetic flux is being applied.

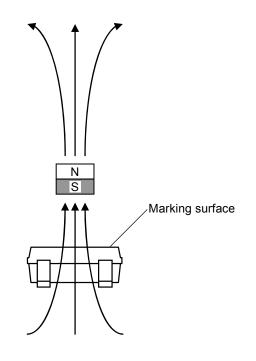


Figure 11

#### 2. Position of Hall sensor

Figure 12 shows the position of Hall sensor.

The center of this Hall sensor is located in the area indicated by a circle, which is in the center of a package as described below.

The following also shows the distance (typ. value) between the marking surface and the chip surface of a package.

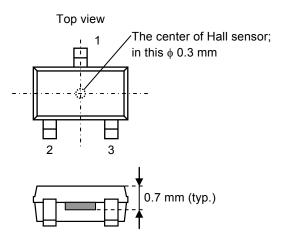


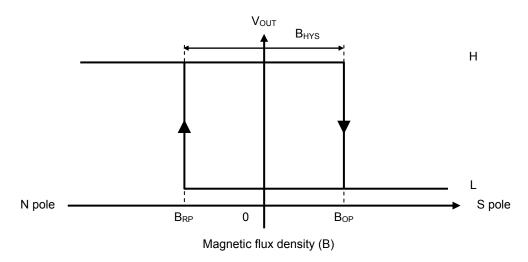
Figure 12

#### 3. Basic operation

This IC changes the output voltage ( $V_{OUT}$ ) according to the level of the magnetic flux density and a polarity change (N pole or S pole) applied by a magnet.

#### 3. 1 Product with V<sub>OUT</sub> = "L" at S pole detection

When the magnetic flux density of the S pole perpendicular to the marking surface exceeds the operation point  $(B_{OP})$  after the S pole of a magnet is moved closer to the marking surface of this IC,  $V_{OUT}$  changes from "H" to "L". When the N pole of a magnet is moved closer to the marking surface of this IC and the magnetic flux density of the N pole is higher than the release point (B<sub>RP</sub>),  $V_{OUT}$  changes from "L" to "H". In case of B<sub>RP</sub> < B < B<sub>OP</sub>,  $V_{OUT}$  retains the status. **Figure 13** shows the relationship between the magnetic flux density and  $V_{OUT}$ .





#### 3. 2 Product with V<sub>OUT</sub> = "H" at S pole detection

When the magnetic flux density of the S pole perpendicular to the marking surface exceeds  $B_{OP}$  after the S pole of a magnet is moved closer to the marking surface of this IC,  $V_{OUT}$  changes from "L" to "H". When the N pole of a magnet is moved closer to the marking surface of this IC and the magnetic flux density of the N pole is higher than  $B_{RP}$ ,  $V_{OUT}$  changes from "H" to "L". In case of  $B_{RP} < B < B_{OP}$ ,  $V_{OUT}$  retains the status. **Figure 14** shows the relationship between the magnetic flux density and  $V_{OUT}$ .

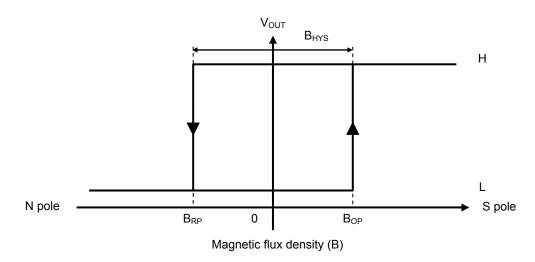


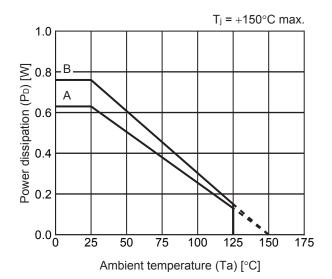
Figure 14

## Precautions

- If the impedance of the power supply is high, the IC may malfunction due to a supply voltage drop caused by feedthrough current. Take care with the pattern wiring to ensure that the impedance of the power supply is low.
- Note that the IC may malfunction if the power supply voltage rapidly changes. When the IC is used under the environment where the power supply voltage rapidly changes, it is recommended to judge the output voltage of the IC by reading it multiple times.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- Although this IC has a built-in output current limit circuit, it may suffer physical damage such as product deterioration under the environment where the absolute maximum ratings are exceeded.
- Although this IC has a built-in reverse voltage protection circuit, it may suffer physical damage such as product deterioration under the environment where the absolute maximum ratings are exceeded.
- The application conditions for the power supply voltage, the pull-up voltage, and the pull-up resistor should not exceed the power dissipation.
- Large stress on this IC may affect on the magnetic characteristics. Avoid large stress which is caused by the handling during or after mounting the IC on a board.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

# Power Dissipation

#### SOT-23-3



Board	Power Dissipation (P <sub>D</sub> )
А	0.63 W
В	0.76 W
С	_
D	_
E	_

# SOT-23-3/3S/5/6 Test Board

) IC Mount Area

# (1) Board A



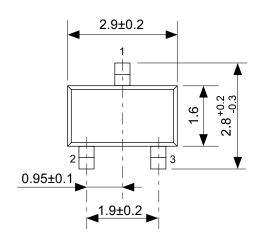
Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	-
	3	-
4		74.2 x 74.2 x t0.070
Thermal via		-

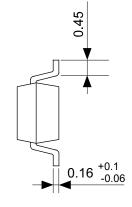
# (2) Board B

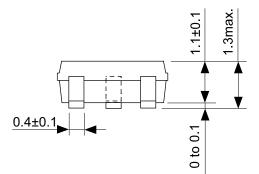


Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Land pattern and wiring for testing: t0.070
Coppor foil lover [mm]	2	74.2 x 74.2 x t0.035
Copper foil layer [mm]	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

No. SOT23x-A-Board-SD-2.0

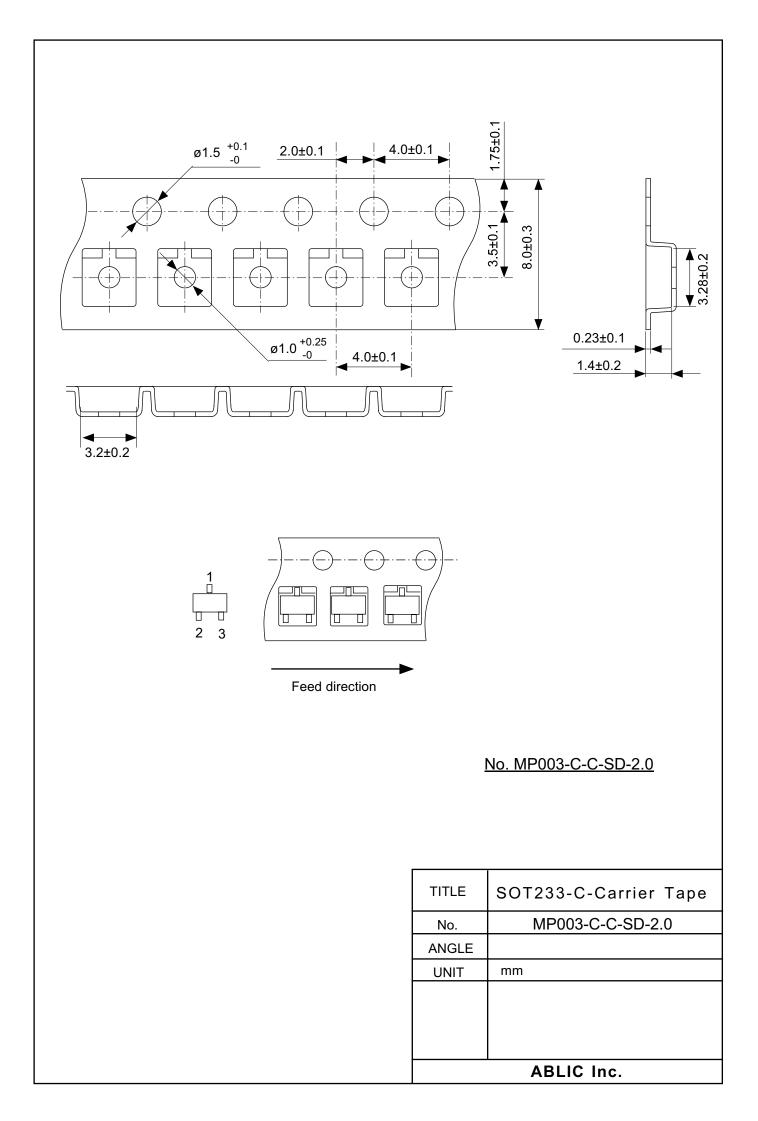


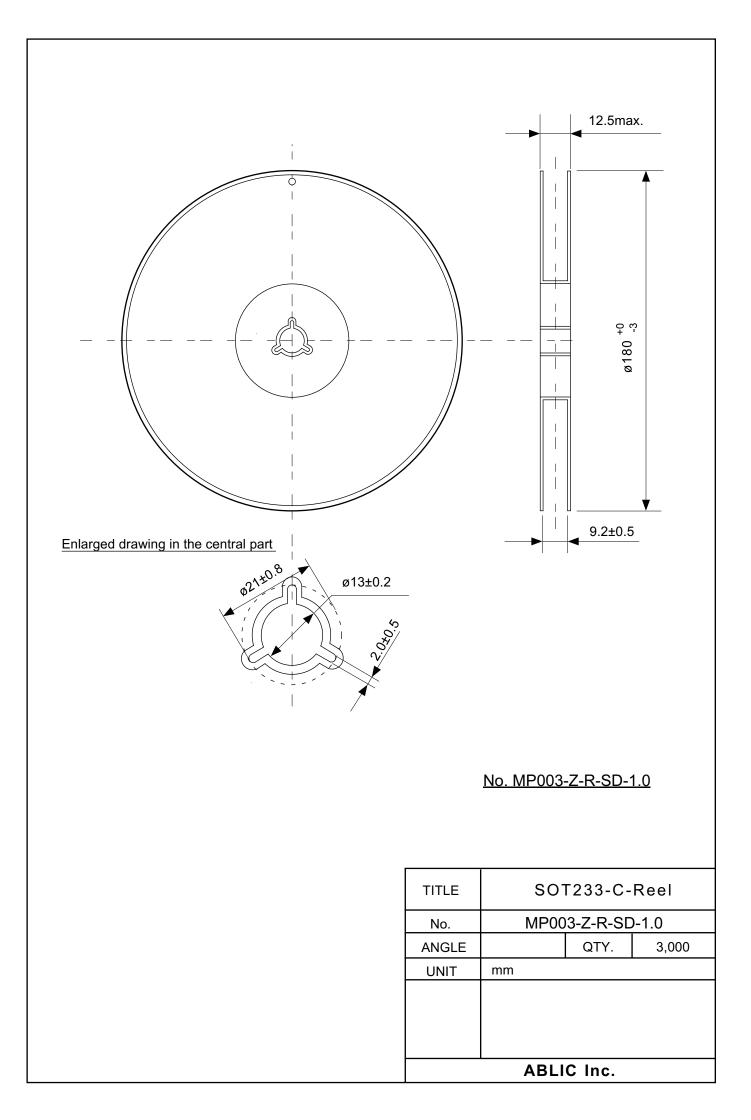




No. MP003-C-P-SD-1.1

TITLE	SOT233-C-PKG Dimensions
No.	MP003-C-P-SD-1.1
ANGLE	$\bigcirc$
UNIT	mm
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# **Disclaimers (Handling Precautions)**

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- The circuit examples and the usages described herein are for reference only, and do not guarantee the success of any specific mass-production design.
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9. Semiconductor products may fail or malfunction with some probability. The user of the products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction. The entire system must be sufficiently evaluated and applied on customer's own responsibility.

- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
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